

Features

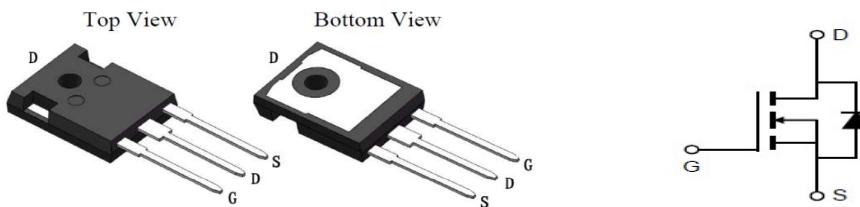
- CRM(CQ) Super_Junction technology
- Much lower Ron*A performance for On-state efficiency
- Better efficiency due to very low FOM
- Ultra-fast body diode
- Qualified for industrial grade applications according to JEDEC

Product Summary

V _{DS,min}	650V
R _{DS(on),typ}	77mΩ
I _D	40A

Applications

- LED/LCD/PDP TV and monitor Lighting
- Solar/Renewable/UPS-Micro Inverter System
- Charger
- Power Supply

100% DVDS Tested**100% Avalanche Tested****Package Marking and Ordering Information**

Part #	Marking	Package	Packing	Reel Size	Tape Width	Qty
CRJQ80N65F	CRJQ80N65F	TO-247-3L	Tube	N/A	N/A	25/30pcs

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	V _{DS}	650	V
Continuous drain current ¹⁾ T _C = 25°C T _C = 100°C	I _D	40 29	A
Pulsed drain current ²⁾ (T _C = 25°C, t _p limited by T _{j,max})	I _{D,pulse}	120	A
Avalanche energy, single pulse (L=30mH)	E _{AS}	750	mJ
MOSFET dv/dt ruggedness	dv/dt	50	V/ns
Gate-Source voltage	V _{GS}	±30	V
Power dissipation (T _C = 25°C)	P _{tot}	470	W
Continuous diode forward current(T _C = 25°C)	I _S	40	A
Diode pulse current ²⁾ (T _C = 25°C)	I _{S,pulse}	120	A
Recovery diode dv/dt ³⁾	dv/dt	50	V/ns
Operating junction and storage temperature	T _j , T _{stg}	-55...+150	°C

1) Limited by T_{j,max}. Maximum Duty Cycle D = 0.502) Pulse width t_p limited by T_{j,max}3) Identical low side and high side switch with identical R_g



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SJMOS N-MOSFET 650V, 77mΩ, 40A

Thermal Resistance

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		
Thermal resistance, junction – case	R _{thJC}	-	0.19	0.27	°C/W	
Thermal resistance, junction – ambient	R _{thJA}	-	-	41	°C/W	

Electrical Characteristic (at T_j = 25 °C, unless otherwise specified)

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		

Static Characteristic

Drain-source breakdown voltage	BV _{DSS}	650	-	-	V	V _{GS} =0V, I _D =250μA
Gate threshold voltage	V _{GS(th)}	3.2	-	4.5	V	V _{DS} =V _{GS} , I _D =250μA
Zero gate voltage drain current	I _{DSS}	-	-	5	μA	V _{DS} =650V, V _{GS} =0V T _j =25°C T _j =150°C
Gate-source leakage current	I _{GSS}	-	-	±100	nA	V _{GS} =±30V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	77	90	mΩ	V _{GS} =10V, I _D =21.5A, T _j =25°C T _j =150°C
Transconductance	g _f	-	30	-	S	V _{DS} =20V, I _D =21.5A

Dynamic Characteristic

Input Capacitance	C _{iss}	-	3445	-	pF	V _{GS} =0V, V _{DS} =100V, f=1MHz
Output Capacitance	C _{oss}	-	134	-		
Reverse Transfer Capacitance	C _{rss}	-	0.6	-		
Gate Total Charge	Q _g	-	84	-	nC	V _{GS} =10V, V _{DS} =480V, I _D =21.5A
Gate-Source charge	Q _{gs}	-	28	-		
Gate-Drain charge	Q _{gd}	-	36	-		
Gate plateau voltage	V _{plateau}	-	7.2	-	V	
Turn-on delay time	t _{d(on)}	-	89	-	ns	V _{GS} =10V, I _D =21.5A, V _{DS} =400V, R _g =27Ω
Rise time	t _r	-	131	-		
Turn-off delay time	t _{d(off)}	-	204	-		
Fall time	t _f	-	69	-		
Gate resistance	R _{g,int}	-	1.0	-	Ω	f=1MHz



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Body Diode Characteristic

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		
Body Diode Forward Voltage	V_{SD}	0.7	0.9	1.1	V	$V_{GS}=0V, I_{SD}=21.5A$
Body Diode Reverse Recovery Time	t_{rr}	-	113		ns	
Body Diode Reverse Recovery Charge	Q_{rr}	-	0.6		μC	$I_{SD}=21.5A$ $dI_F/dt=100A/\mu s$ $V_{DS}=400V$
Body Diode Reverse Recovery Peak Current	I_{rrm}	-	10	-	A	

Typical Performance Characteristics

Fig 1. Output Characteristics ($T_j=25^\circ\text{C}$)

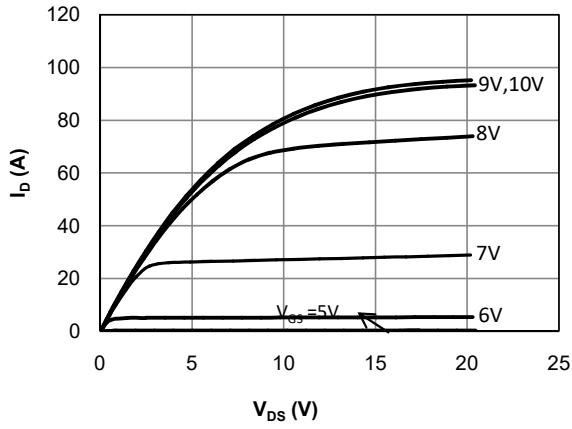


Fig 2. Output Characteristics ($T_j=150^\circ\text{C}$)

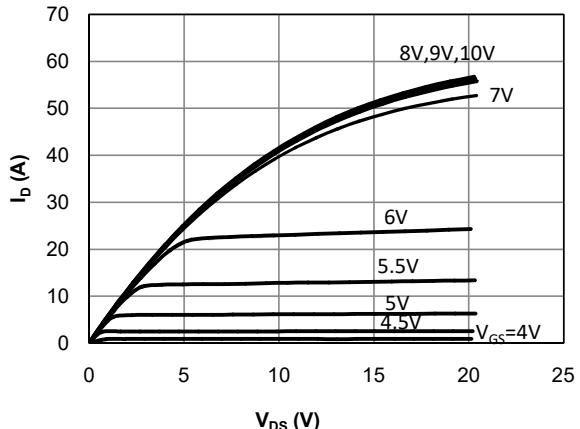


Fig 3: Transfer Characteristics

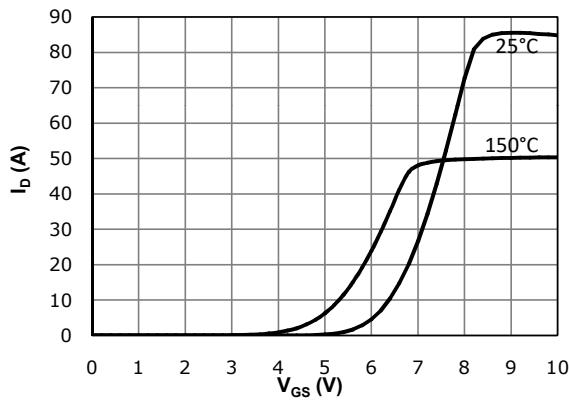


Fig 4: V_{TH} vs. T_j Temperature Characteristics

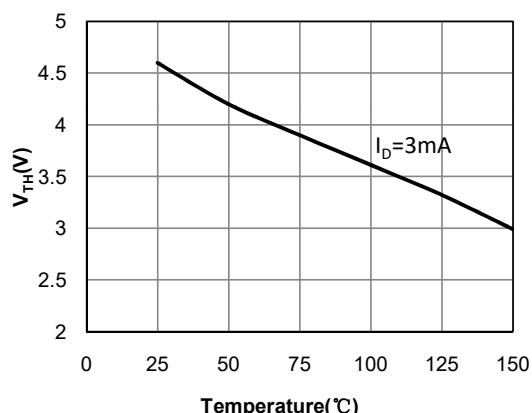


Fig 5: $R_{DS(on)}$ vs. I_{DS} Characteristics ($T_j=25^\circ\text{C}$)

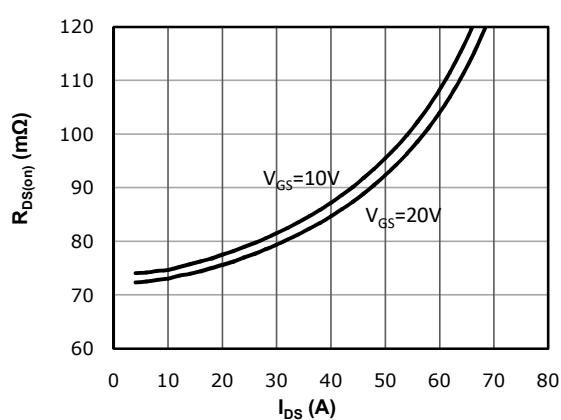


Fig 6: $R_{DS(on)}$ vs. Temperature

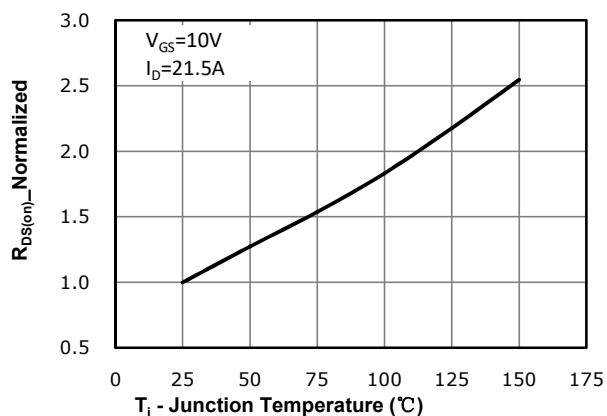


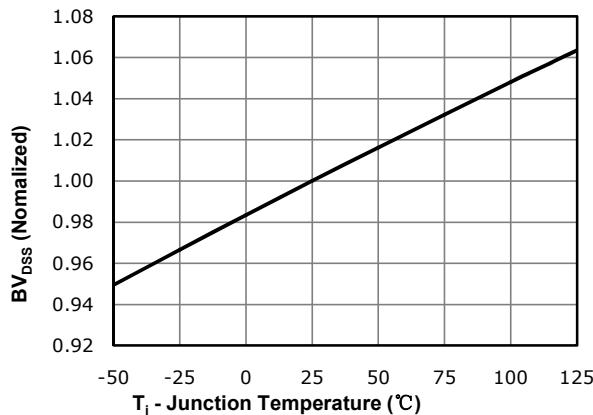
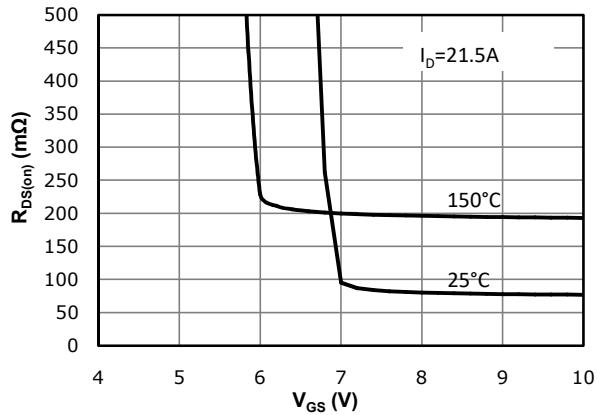
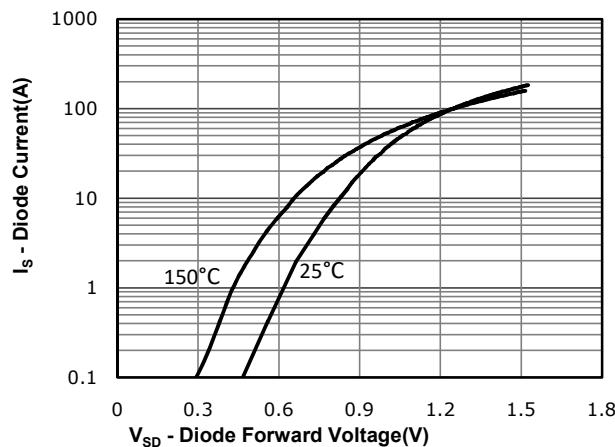
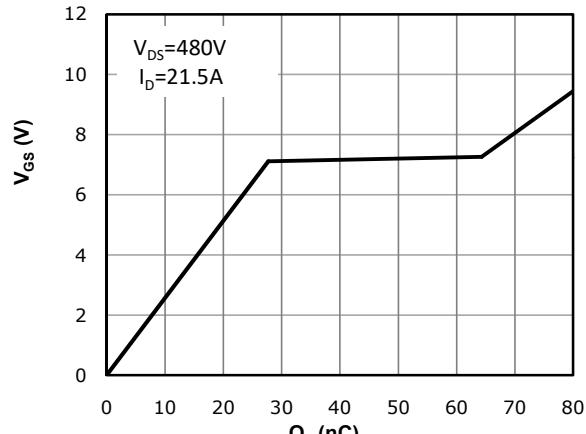
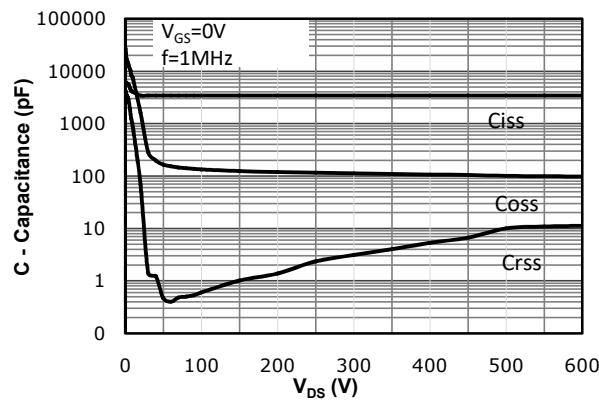
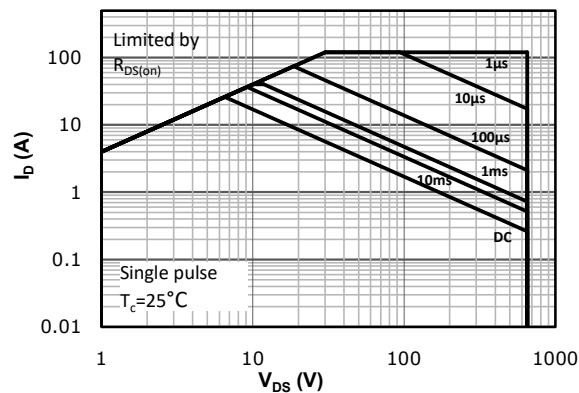
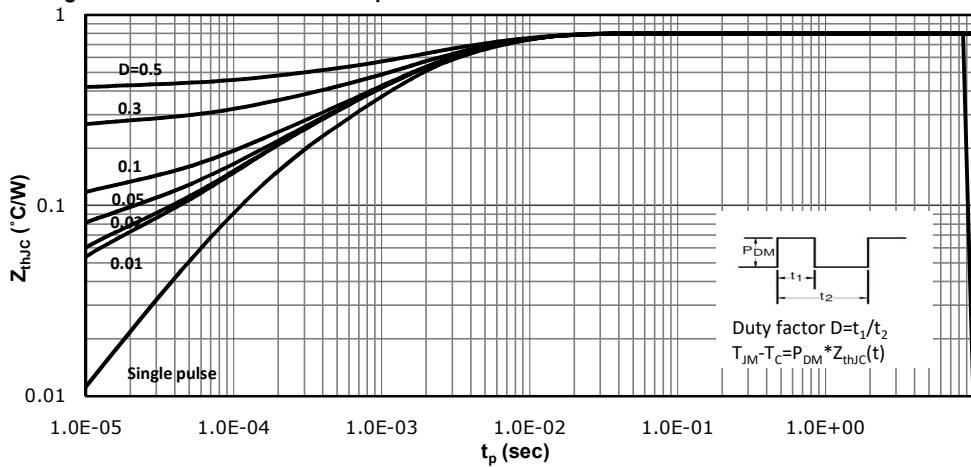
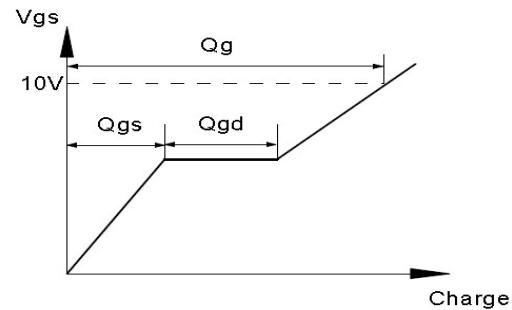
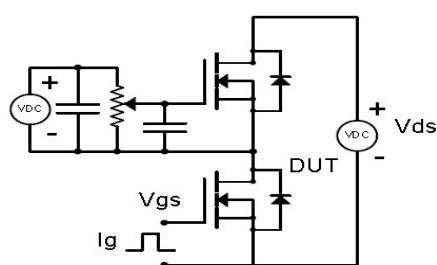
Fig 7: BV_{DSS} vs. Temperature

Fig 8: R_{DS(on)} vs. Gate Voltage

Fig 9: Body-diode Forward Characteristics

Fig 10: Gate Charge Characteristics

Fig 11: Capacitance Characteristics

Fig 12: Safe Operating Area


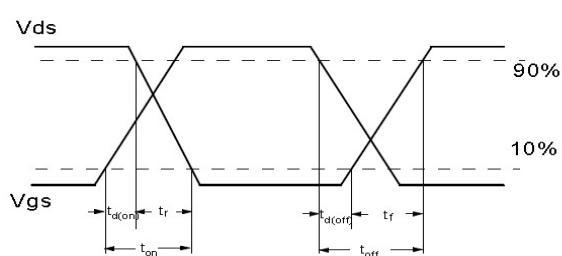
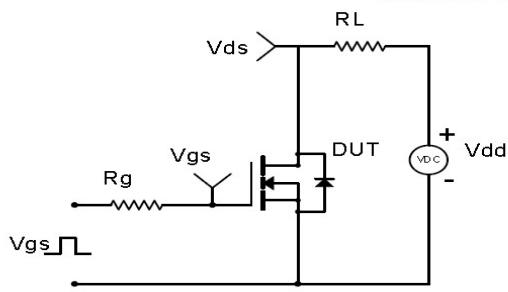
Fig 13: Max. Transient Thermal Impedance

Test Circuit & Waveform

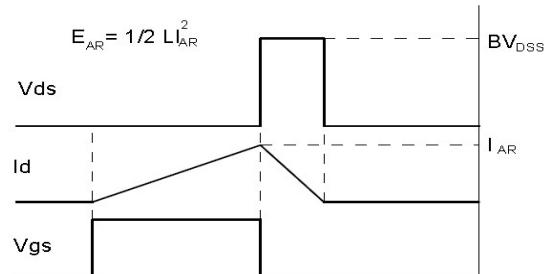
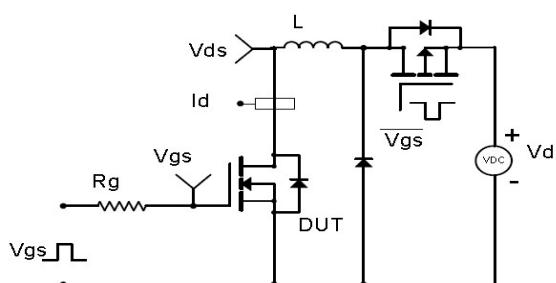
Gate Charge Test Circuit & Waveform



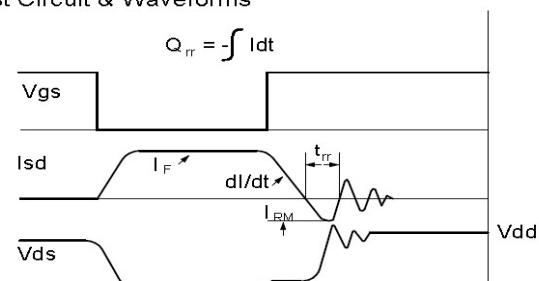
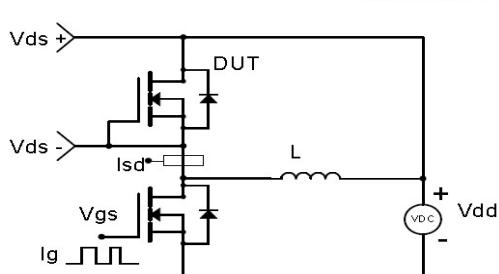
Resistive Switching Test Circuit & Waveforms

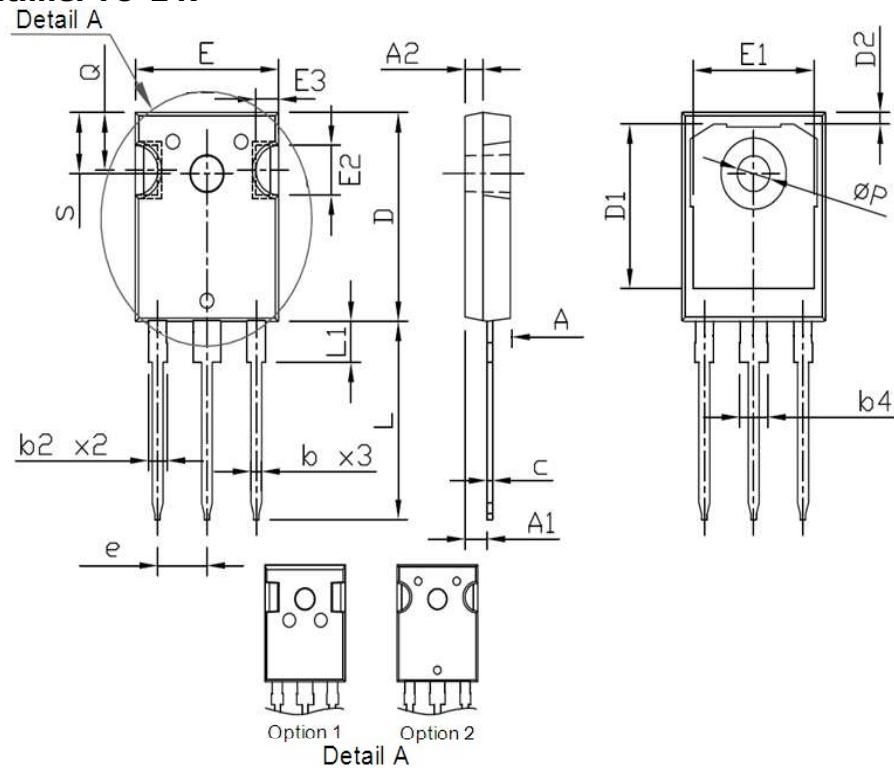


Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



Package Outline: TO-247

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.70	5.30	0.185	0.209
A1	2.20	2.60	0.087	0.102
A2	1.50	2.49	0.059	0.098
b	1.04	1.33	0.041	0.052
b2	1.90	2.41	0.075	0.095
b4	2.87	3.43	0.113	0.135
c	0.55	0.70	0.022	0.028
D	20.70	21.30	0.815	0.839
D1	16.25	17.65	0.640	0.695
D2	0.51	1.40	0.020	0.055
e	5.44 BSC.		0.214 BSC.	
E	15.50	16.30	0.610	0.642
E1	13.08	14.16	0.515	0.557
E2	3.80	5.49	0.150	0.216
E3	1.00	2.75	0.039	0.108
L	19.72	20.32	0.776	0.800
L1	3.85	4.50	0.152	0.177
Q	5.25	6.25	0.207	0.246
P	3.50	3.70	0.138	0.146
S	6.04	6.30	0.238	0.248



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Marking



NOTE:

NXBBAAAA

N —WB code (Usually omitted)

X —Assembly location code

BB —Fab code

AAAA —Lot code



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SJMOS N-MOSFET 650V, 77mΩ, 40A

Revision History

Revison	Date	Major changes
3.2	2023/8/22	Update Static Characteristics

Disclaimer

Unless otherwise specified in the datasheet, the product is designed and qualified as a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability, such as automotive, aviation/aerospace and life-support devices or systems.

Any and all semiconductor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.

CRM(CQ) reserves the right to improve product design, function and reliability without notice.